# OPTICAL FILTER CONSTRUCTION BY ATOMIC LAYER CONTROL FOR NEXT GENERATION DENSE WAVELENGTH DIVISION MULTIPLEXER

## 5 I. Background Of The Invention

#### A. Field Of The Invention

This application claims priority to U.S. Provisional Patent Application Serial No. 60/206,934, entitled OPTICAL FILTER CONSTRUCTION BY ATOMIC LAYER CONTROL FOR NEXT GENERATION DENSE WAVELENGTH DIVISION MULTIPLEXER, filed on May 25, 2000, U.S. Provisional Patent Application Serial No. 60/207, 100, entitled ATOMIC LAYER CONTROLLED OPTICAL FILTER DESIGN FOR NEXT GENERATION DENSE WAVELENGTH DIVISION MULTIPLEXER, filed on May 25, 2000, and U.S. Provisional Patent Application Serial No. 60/207,101, entitled CHEMICAL-ORGANIC PLANARIZATION PROCESS FOR ATOMICALLY SMOOTH INTERFACES, filed on May 25, 2000. The present invention relates to an oxygen ion process called Chemical Reactive-Ion Surface Planarization (CRISP) which reduces the surface roughness of thin film surfaces at the atomic level.

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#### B. Description Of The Related Art

The present invention contemplates a new and improved process for reducing the surface roughness of thin films which is simple in design, effective in use, and overcomes the foregoing difficulties and others while providing better and more advantageous overall results.

There are many commercial applications for thin films and, in particular, multilayer films. One particularly promising application is the use of these films in fiber-optic networks. Multilayered films are used in Dense Wavelength Division

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Multiplexers/Demultiplexers (DWDM) systems which enable information to be delivered inside the fiber optic cables at multiple wavelengths.

The ability to transmit data via fiber optic cables has become of increasing importance in this technological age. At the present time, the installation of a world-wide fiber-optic network is in progress which will be capable of handling levels of data transmission inconceivable only several years ago. As a result of this network, the Internet is less than half a decade away from being a more useful tool than the computers which navigate it. As the biggest technological revolution in the history of modern civilization progresses, advanced high performance coatings have emerged as the enabling technology. The ability to control transmission and reflection of selected wavelengths of light has enabled existing fiber to accommodate the increase in bandwidth which will be required over the next 3-5 years.

Dense Wavelength Division Multiplexers/Demultiplexer (DWDM) systems enable information to be delivered inside fiber-optic cables at multiples wavelengths. The increase in the bandwidth is limited only by the number of wavelengths which can be superimposed on the fiber. Current state- of-the-art DWDMs can multiplex/demultiplex approximately 130+ channels. Ultimately more than 1000 channels will be possible. During transmission, information is packaged within phase modulated carriers at specific wavelengths and superimposed (multiplexing) on the fiber. During reception, the carriers must be separated (demultiplexing). Optical component technology such as DWDMs are critical to achieve bandwidth necessary for future interactive services such as "video on demand," and have prompted multi-billion dollar strategic acquisitions such as OCLI, NetOptix, and XROS.

The most widely used technology for multiplexing and demultiplexing in DWDM systems is thin film-based. Multilayered thin dielectric coatings are comprised of 150-200 layers with individual optical layer thickness equal to multiples of ¼ of the

wavelength to be transmitted (known as dielectric interference filters). A collection of such filters coupled together, each differing slightly in design to allow light transmission of different wavelengths, and "connected" to a fiber-optic cable enables the multiplexing (superposition) and demultiplexing (separation) of multiple wavelengths of laser light containing digital information.

Current thin film multiplexers and demultiplexers can handle up to 40 different wavelengths but several manufacturers have announced 80 channel versions in year 2000. With current state-of-the-art deposition processes used for DWDM, 80 channel multiplexers will approach the limit of the technology. Theoretical thin film filter designs exist with Full Width at Half Maximum (FWHM) of less than 0.1 nm. Such a filter would enable multiplexers capable of handling more than 1000 channels.

Thin film coatings designed to permit light transmission/reflection over narrow (0.1 - 25 nm) and broad (> 25 nm) pass bands are typically comprised of multiple layers of two or more optically matched materials of "high" and "low" indices of refraction. The individual layer thickness and number of layers will ultimately define the optical performance of the filter. Typical narrow band filters (called "high performance") may have more than 100 individual layers.

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High performance dielectric thin film optical filters are produced in volume for state-of-the-art multiplexers and demultiplexers used in DWDM systems. These filters are produced with materials such as SiO<sub>2</sub> and Ta<sub>2</sub>O<sub>5</sub> deposited with processes such as ion beam sputter deposition (ISBD) and ion-assisted deposition (IAD). Filters produced with these processes are stable under adverse environmental conditions but lack necessary thickness and roughness control to multiplex/demultiplex more than 80 channels in the desired wavelength range. This is primarily due to excessive roll off of the filter which leads to full width at half maximum (FWHM) of greater than 2 nm (250 GHz).





Surface roughness at interfaces and thickness control are critical factors in determining the performance of a narrow bandpass filter. State-of-the-art filters will incorporate interfacial roughness which increases exponentially with layer number and is ultimately greater than 10% of the layer thickness. Furthermore, in-situ optical and physical thickness monitoring techniques are accurate to within 0.5%. This level of layer control has enabled narrow bandpass filters on the order of 1 nm FWHM (125 GHz).

Surface roughness reduction and interface smoothing by ion bombardment has been examined extensively for multilayered films designed for x-ray reflectors. In that collection of work it was observed that, by ion polishing the film surfaces using Ar<sup>+</sup> or O<sup>+</sup> ions accelerated from an ion source, surface roughness (R<sub>a</sub>) was reduced by a factor of 2. It was also observed that deposition of a thin amorphous carbon (C) layer at each interface, between layers of multilayered reflectors, was successful at reducing interface roughness.

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Diamond-like carbon (DLC) produced with plasma-based processes such as ion beam deposition (IBD) and plasma enhanced chemical vapor deposition (PECVD) is a smooth, amorphous and virtually lossless carbon coating. Since the material can be made more than 99% transmissive in the infrared (IR, 800 nm - 15  $\mu$ m) and has a refractive index of n = 2.0, it is commonly used for many IR window applications. Intrinsic stress is compressive and can be quite high ultimately leading to cracking and delamination in coatings greater than 3.0  $\mu$ m thick. These coatings are also used for anti-abrasion since DLC produced with ion beam processes such as IBD or PECVD is a very hard low surface roughness amorphous carbon coating.

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Diamond-like carbon (DLC), and other forms of amorphous carbon, can be stripped from substrates by exposing the surface to an energetic (> 50V) oxygen plasma. The energetic oxygen ions react chemically with the carbon surface to form carbon monoxide (CO). The vapor pressure of CO is high enough, at the vacuum level at which





this process is performed ( $\sim 10^{-2}$  torr), that the CO molecules evaporate from the surface. The freshly exposed surface carbon then reacts with the plasma and the process continues until the oxygen plasma is extinguished or no amorphous carbon remains.

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## II. Summary Of The Invention

An optical filter has been developed which uses, but is not limited to, alternating layers of high index materials such as titanium oxide (TiO<sub>2</sub>, n = 2.2 @ 1.55  $\mu$ m), amorphous silicon (Si, n=3.46 @ 1.55  $\mu$ m), and tantalum pentoxide (Ta<sub>2</sub>O<sub>5</sub>, n = 2.05 @ 1.55  $\mu$ m), and low index materials such as silicon dioxide (SiO<sub>2</sub>, n = 1.45 @ 1.55  $\mu$ m) and magnesium fluoride (MgF<sub>2</sub>, n = 1.35 @ 1.55  $\mu$ m), to enable next generation multiplexers and demultiplexers for DWDM systems. The optical filter is unique in that it uses atomic layer deposition processes commonly used in the semiconductor industry and a Chemical Reactive-Ion Surface Planarization (CRISP) process to produce atomically smooth (R<sub>a</sub> < 0.01 nm) interfaces. The filter will enable narrow bandpass filters of ~ 12.5 GHz with the necessary environmental stability to construct next generation optical communications hardware.

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In accordance with one aspect of the present invention, a process for optical filter construction includes the steps of growing high index layers via a self-limiting deposition process chosen from the group comprising: atomic layer epitaxy, pulsed chemical beam epitaxy, molecular layer epitaxy, and laser molecular beam epitaxy, growing low index layers, depositing the high and low index layers onto a substrate, monitoring, during deposition, the layer growth, the high index layer being monitored via reflection high energy electron diffraction (or a similar in-situ technique), the low index layer being monitored via interferometric technique capable of sub-angstrom resolution, monitoring intrinsic stress using an in-situ cantilever-based intrinsic stress optical monitor, adjusting the intrinsic stress via deposition parameter modification, monitoring indices of refraction

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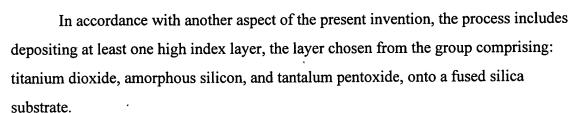
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during deposition via an in-situ ellipsometer, measuring surface roughness using a reflection technique chosen from the group comprising: p-polarized reflection spectroscopy, phase modulated ellipsometry, and real-time atomic force microscopy, depositing approximately a 1-10 nanometer thick first layer of amorphous diamond-like (or optically similar) carbon onto the layer, directing a well-focused oxygen ion beam onto the carbon coated layer at near grazing incidence, rastering the ion beam in a sweeping fashion to allow interaction with only the carbon which protrudes above average surface height, the rastering being continued until a top layer of carbon is reduced to the level of the highest peaks in the layer, and repeating the process as necessary, alternating the high and low index layers.

In accordance with another aspect of the present invention, a process for optical filter construction includes the steps of depositing at least one layer, the layer chosen from the group comprising high index and low index, onto a substrate, monitoring layer growth, monitoring intrinsic stress, adjusting intrinsic stress, if necessary, monitoring indices of refraction, depositing amorphous carbon onto the at least one layer, directing an ion beam onto the carbon coated layer, and reducing the carbon layer until the carbon layer is approximately atomically smooth.

In accordance with yet another aspect of the present invention, the process includes depositing a high index layer onto a substrate.

In accordance with still another aspect of the present invention, the process includes depositing a low index layer onto the carbon coated high index layer, monitoring layer growth, monitoring intrinsic stress, adjusting intrinsic stress, if necessary, monitoring indices of refraction, depositing amorphous carbon onto the low index layer, directing an ion beam onto the carbon coated low index layer, and reducing the carbon layer until the carbon layer is approximately atomically smooth.



In accordance with yet another aspect of the present invention, the process includes depositing a low index layer, the layer chosen from the group comprising: silicon dioxide and magnesium fluoride, onto a fused silica substrate.

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Still other benefits and advantages of the invention will become apparent to those skilled in the art upon a reading and understanding of the following detailed specification.

## III. Brief Description Of The Drawings

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The invention may take physical form in certain parts and arrangement of parts.

At least one embodiment of these parts will be described in detail in the specification and illustrated in the accompanying drawing, which form a part of this disclosure and wherein:

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FIGURE 1 is an illustration showing the inventive multilayered optical filter.

### IV. Description Of The Invention

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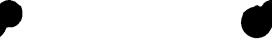
Referring now to the drawings, which are for purposes of illustrating at least one embodiment of the invention only, and not for purposes of limiting the invention, FIGURE 1 shows an optical filter which uses alternating layers of high index materials such as, but not limited to, titanium dioxide ( $TiO_2$ , n = 2.2 @ 1.55  $\mu m$ ), amorphous

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silicon (Si, n=3.46 @ 1.55  $\mu$ m), and tantalum pentoxide (Ta<sub>2</sub>O<sub>5</sub>, n = 2.05 @ 1.55  $\mu$ m), and low index materials such as, but not limited to, silicon dioxide (SiO<sub>2</sub>, n = 1.45 @ 1.55  $\mu$ m) and magnesium fluoride (MgF<sub>2</sub>, n = 1.35 @ 1.55  $\mu$ m).

The high index layers are grown with a self-limiting deposition process, which include, but are not limited to, atomic layer epitaxy (ALE), pulsed chemical beam epitaxy (PCBE), molecular layer epitaxy (MLE), or molecular beam epitaxy (MBE), which can result in layer-by-layer growth. In some cases a polycrystalline or amorphous layer will grow but the atomic layer control is maintained. The low index materials exhibit the same growth behavior (SiO<sub>2</sub> is typically amorphous at the desired deposition temperatures). For materials which grow epitaxially, reflection high energy electron diffraction (RHEED) can be used to monitor layer growth during deposition. For layers which are amorphous, in this embodiment, layer thickness is monitored during deposition using an interferometric technique which is capable of sub-angstrom resolution. These monitoring processes enable thickness control to within one atomic layer.

Although each layer can be controlled to within one atomic layer, surface roughness plays a major role in determining filter performance. The epitaxial processes which enable atomic layer control produce surfaces with roughness on the order of 0.1 nm. This is insufficient to produce filters on the order of 12.5 GHz. The surface roughness is measured in-situ using a reflection technique which include, but are not limited to, p-polarized reflection spectroscopy (PRS), phase modulated ellipsometry (PME) or real time atomic force microscopy (AFM).

In this embodiment, after the surface roughness has been determined, a surface planarization process is employed. The process uses the surface roughness reduction effect of oxygen ions along with the reactive nature of amorphous carbon in an oxygen ion environment to planarize vacuum grown thin films. At the end of a layer deposition, the thin film which remains is a high quality dielectric film on the order of 150 nm thick

with a surface roughness of  $\sim 0.1$  nm. At that time a very thin layer of amorphous diamond-like carbon, approximately 1-10 nm thick, is deposited by PECVD, IBD, or some similar process.

After the carbon layer is deposited a well-focused oxygen ion beam is directed onto the carbon-coated surface at near grazing incidence. The ion beam energy is set high enough to minimize the spread of the beam. The ion beam is rastered in a sweeping fashion so as to allow interaction with only the carbon which protrudes up above the average surface height. This process is maintained until the top layer of carbon has been reduced to the level of the highest peaks in the surface of the thin film (e.g. SiO<sub>2</sub>). This has the ultimate effect of filling in the valleys and leveling the initially rough surface.

A representative filter is shown in FIGURE 1 which depicts epitaxially grown TiO<sub>2</sub> with atomic layer control, and alternating layers of amorphous SiO<sub>2</sub> made atomically smooth using the planarization process. Each surface can be planarized if necessary. The optical properties of the amorphous carbon layer must be incorporated into the final design of the filter. If individual layer surface roughness does not require further planarization, the process is used only when necessary. The planarization process is performed until the surface roughness is reduced to approximately less than 0.01 nm.

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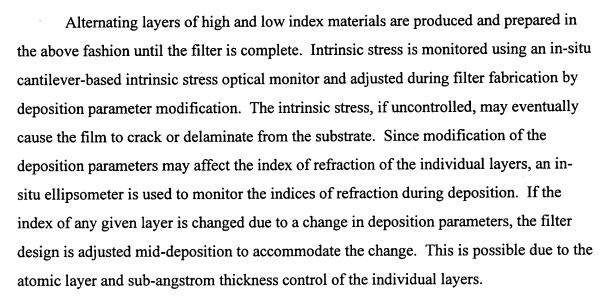
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The resulting filter has sufficient individual layer thickness control and surface roughness to enable  $\sim 12.5$  GHz filters for next generation multiplexers and demultiplexers with more than 1000 channels in the wavelength range 1.31 - 1.62  $\mu m$ .

The invention has been described with reference to at least one embodiment. Obviously, modifications and alterations will occur to others upon a reading and understanding of the specification. It is intended by applicant to include all such modifications and alterations insofar as they come within the scope of the appended claims or the equivalents thereof.

Having thus described the invention, it is now claimed: